

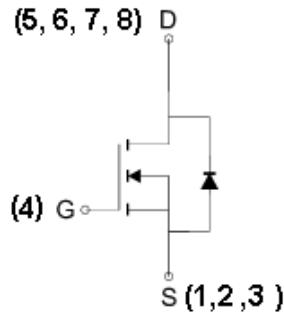
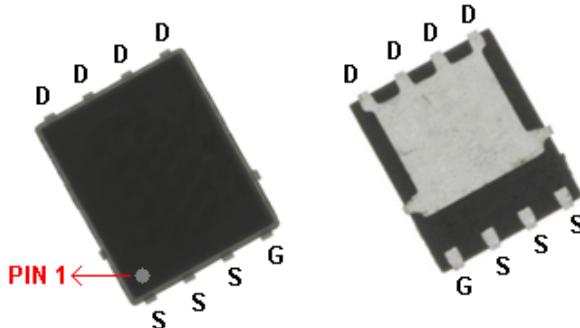
N-Channel 30V(D-S) Enhancement MOSFET

GENERAL DESCRIPTION

The ME7636 is the N-Channel logic enhancement mode power field effect transistors are produced using high cell density , DMOS trench technology. This high density process is especially tailored to minimize on-state resistance. These devices are particularly suited for low voltage application such as notebook computer power management and other battery powered circuits where Low-side switching , and low in-line power loss are needed in a very small outline surface mount package.

PIN CONFIGURATION

PowerDFN 5x6



N-Channel MOSFET

FEATURES

R_{DS(ON)} 2.5mΩ@V_{GS}=10V

R_{DS(ON)} 3.3mΩ@V_{GS}=4.5V

Super high density cell design for extremely low R_{DS(ON)}

Exceptional on-resistance and maximum DC current capability

APPLICATIONS

Power Management in Note book

NB/MB Vcore Low side switching

Portable Equipment

Battery Powered System

DC/DC Converter

Load Switch

Ordering Information: ME7636 (Pb-free)

ME7636-G (Green product-Halogen free)

Absolute Maximum Ratings (T_A=25 Unless Otherwise Noted)

Parameter	Symbol	Maximum Ratings		Unit
Drain-Source Voltage	V _{DS}	30		V
Gate-Source Voltage	V _{GS}	±20		V
Continuous Drain*	T _C =25	I _D	97	A
	T _C =70		77	
	T _A =25		26	
	T _A =70		21	
Pulsed Drain Current	I _{DM}	105		A
Maximum Power Dissipation*	T _A =25	P _D	2.78	W
	T _A =70		1.78	
Operating Junction Temperature	T _J	-55 to 150		
Thermal Resistance-Junction to Ambient*	R _{θJA}	Steady State	45	/W
Thermal Resistance-Junction to Case*	R _{θJC}	3.3		/W

*The device mounted on 1in² FR4 board with 2 oz copper

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Electrical Characteristics (TA = 25 Unless Otherwise Specified)

Symbol	Parameter	Limit	Min	Typ	Max	Unit
STATIC						
V(BR)DSS	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250 μA	30			V
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250 μA	1.3		3.0	V
I _{GSS}	Gate Leakage Current	V _{DS} =0V, V _{GS} =±20V			±100	nA
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =30V, V _{GS} =0V			1	μA
R _{DS(ON)}	Drain-Source On-State Resistance ^a	V _{GS} =10V, I _D =27A		1.9	2.5	m
		V _{GS} =4.5V, I _D =20A		2.5	3.3	
V _{SD}	Diode Forward Voltage	I _S =2.8A, V _{GS} =0V		0.75	1.1	V
DYNAMIC						
Q _g	Total Gate Charge	V _{DS} =15V, V _{GS} =4.5V, I _D =27A		58		nC
Q _{gs}	Gate-Source Charge			23		
Q _{gd}	Gate-Drain Charge			30		
C _{iss}	Input Capacitance	V _{DS} =15V, V _{GS} =0V, F=1MHz		5930		pF
C _{oss}	Output Capacitance			660		
C _{rss}	Reverse Transfer Capacitance			220		
R _g	Gate-Resistance	V _{DS} =0V, V _{GS} =0V, F=1MHz		0.85		
t _{d(on)}	Turn-On Delay Time	V _{DD} =15V, R _L =15 I _D =1A, V _{GEN} =10V R _G =6		36		Ns
t _r	Turn-On Rise Time			23		
t _{d(off)}	Turn-Off Delay Time			170		
t _f	Turn-Off Fall Time			44		

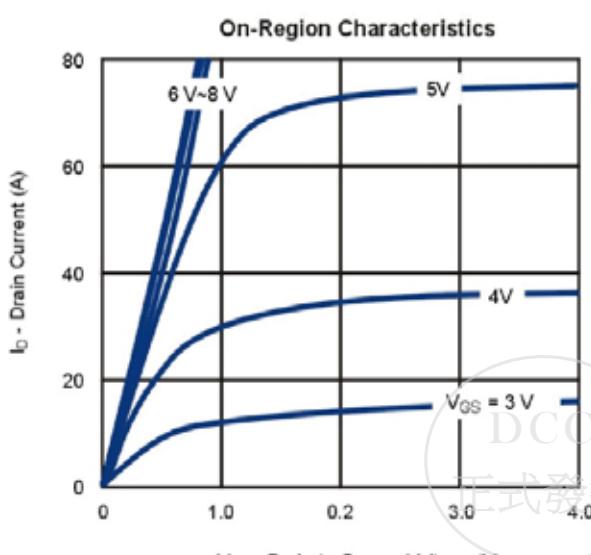
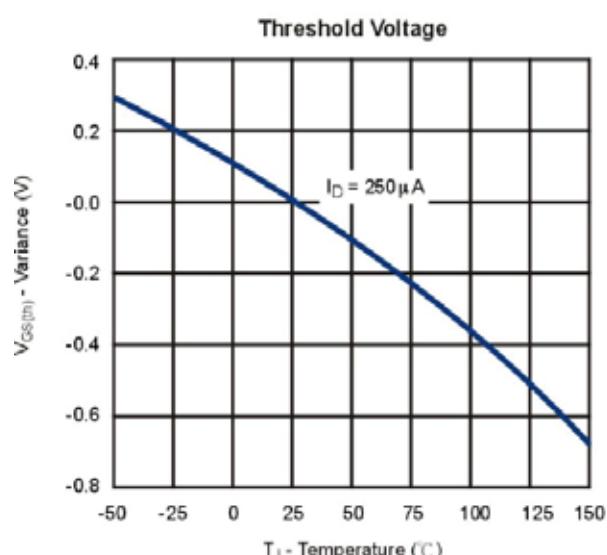
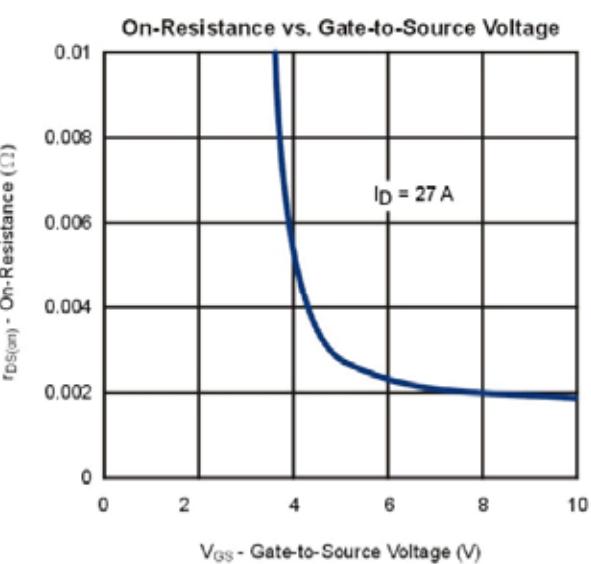
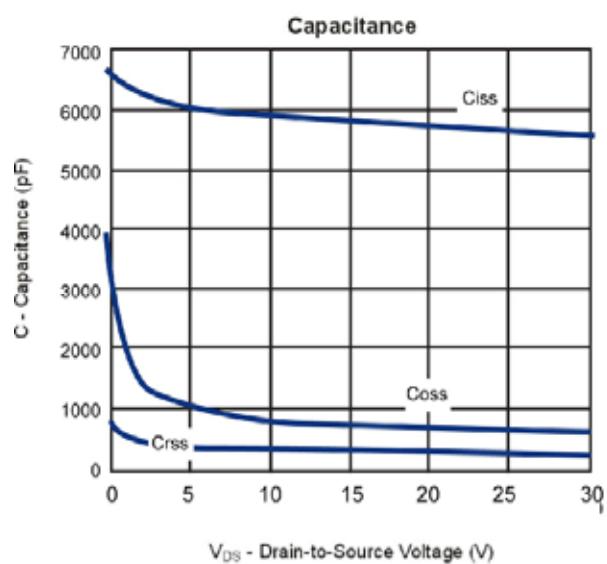
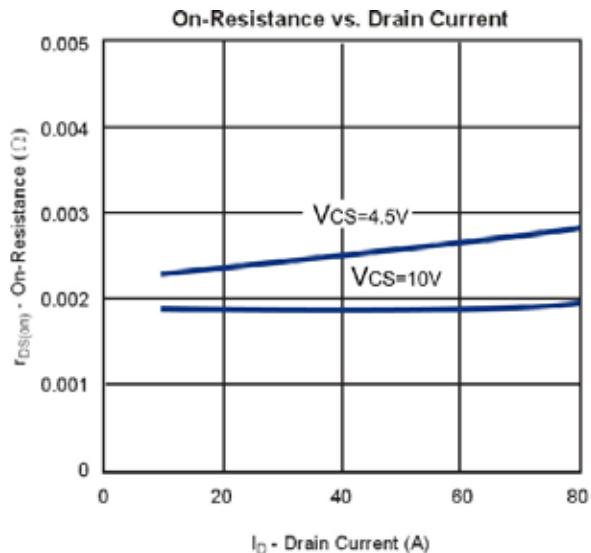
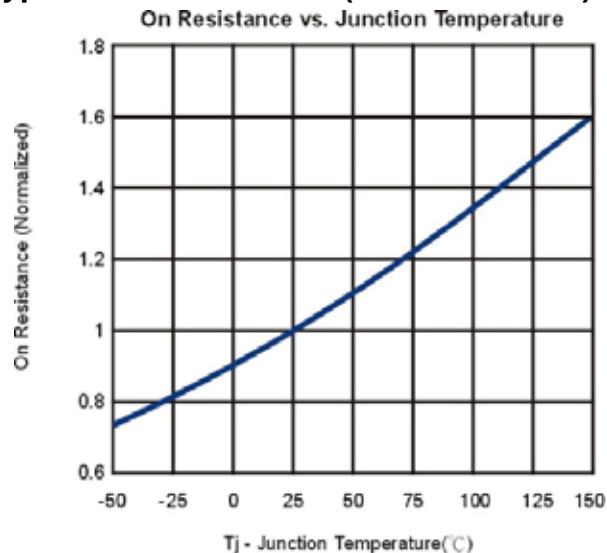
Notes: a. Pulse test: pulse width 300us, duty cycle 2%, Guaranteed by design, not subject to production testing.

b. Matsuki Electric/ Force mos reserves the right to improve product design, functions and reliability without notice.



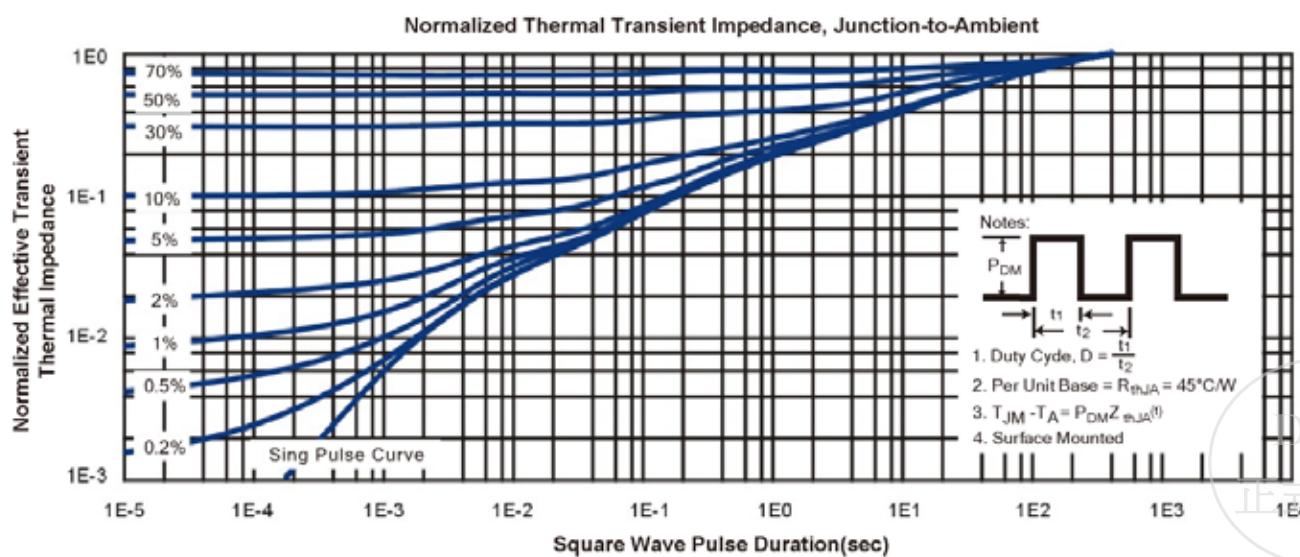
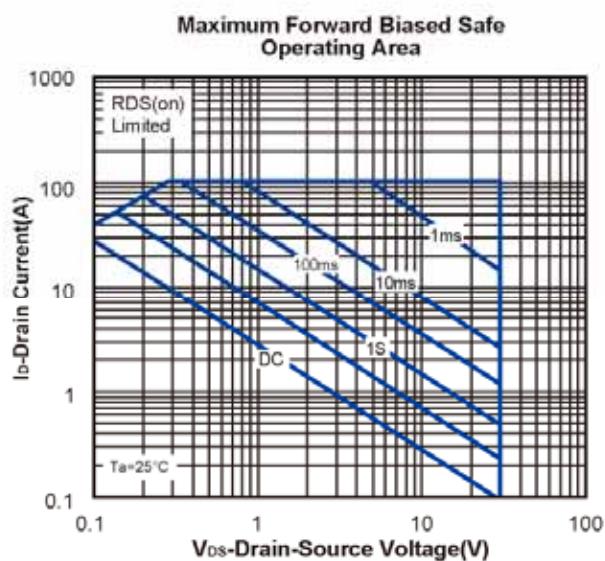
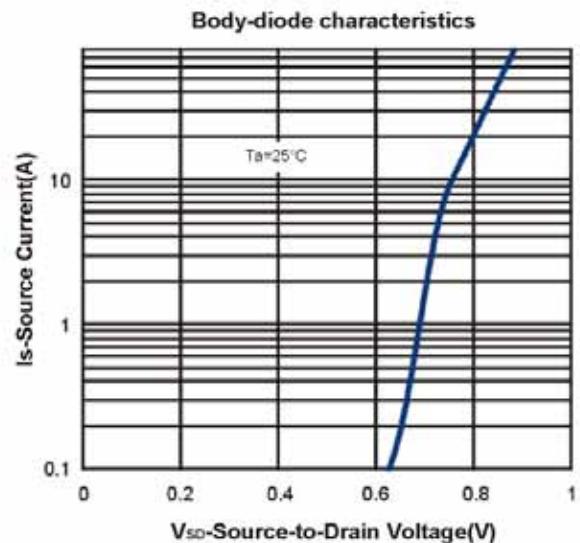
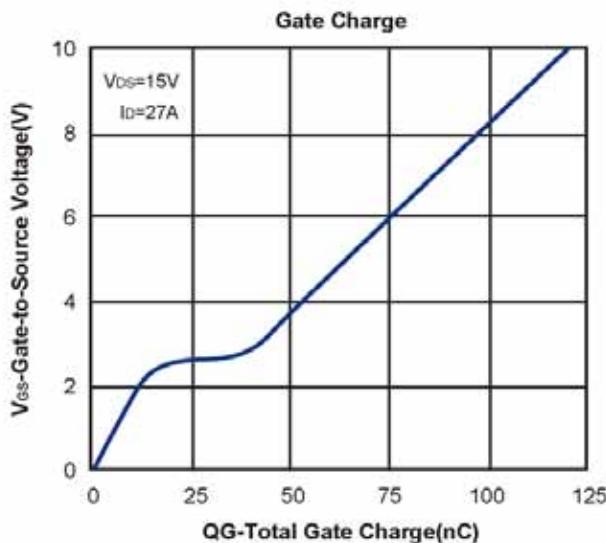
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Typical Characteristics (T_J =25 Noted)



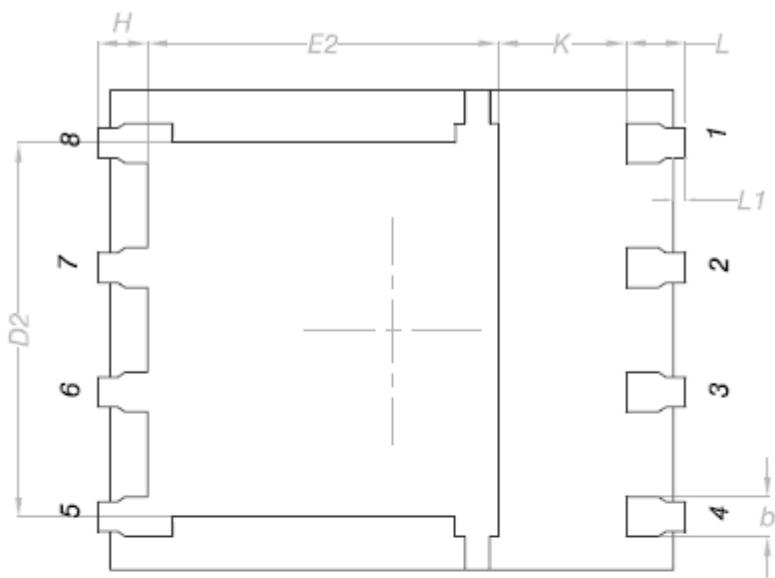
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PowerDFN 5x6 Package Outline



BACKSIDE VIEW

DIM.	MILLIMETERS		
	MIN.	NOM.	MAX.
A	0.90	1.00	1.10
b	0.33	0.41	0.51
C	0.20	0.25	0.30
D1	4.80	4.90	5.00
D2	3.61	3.81	3.96
E	5.90	6.00	6.10
E1	5.70	5.75	5.80
E2	3.38	3.58	3.78
e	1.27 BSC		
H	0.41	0.51	0.61
K	1.10	-	-
L	0.51	0.61	0.71
L1	0.06	0.13	0.20
α	0°	-	12°

